12500 TI Boulevard, MS 8640, Dallas, Texas 75243

Notification Number:	20260929004.0	Notification Issued	September 29, 2026
Datasheet for TPS65216			

Change Type(s)	Data Sheet/Electrical Specification

Notification Details

Description of Change:

Texas Instruments Incorporated is announcing an information only notification.
The product datasheet(s) is being updated as summarized below.
The following change history provides further details.

TPS65216
SLDS187C – OCTOBER 2018 – REVISED JUNE 2026

Changes from Revision B (January 2026) to Revision C (June 2026) **Page**

- Changed VIN range minimum from 3.6 V to 2.7 V for DCDC1-4 1
- Changed minimum from 3.6 V to 2.7 V for IN_BIAS and Input voltage for DCDC1, DCDC2, DCDC3, and DCDC4 7
- Changed minimum from 3.6 V to 2.7 V for V_{IN_BIAS} , V_{IN_DCDC1}, V_{IN_DCDC2}, V_{IN_DCDC3}, and V_{IN_DCDC4} 8
- Changed references to system power minimum 3.6 V to 2.7 V in the *Functional Block Diagram* 18
- Changed 3.6-V to 2.7-V for minimum system power voltage in *Typical Application* Figure 77

The datasheet number will be changing.

Device Family	Change From:	Change To:
TPS65216	SLDS187B	SLDS187C

These changes may be reviewed at the datasheet links provided.

http://www.ti.com/product/TPS65216

Reason for Change:	To accurately reflect device characteristics

Anticipated impact on Form, Fit, Function, Quality or Reliability:	None
Changes to product identification resulting from this PCN:	None

Products Affected:			
TPS65216D0RSLR	TPS65216D0RSLR.A	TPS65216D0RSLRG4	TPS65216D0RSLRG4.A
TPS65216D0RSLT	TPS65216D0RSLT.A		

In performing change qualifications, Texas Instruments follows integrated circuit industry standards in performing defect mechanism analysis and failure mechanism-based accelerated environmental testing to ensure wafer fab process, assembly process and product quality and

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